IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rig international and Pan-American copyright conventions			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				Materials	ials and Mfg Information				
upplier	· Information														
ompany	name*	Company unique ID			J	Unique ID Authority				R	Response Date*				
nsemi											20	2023-06-08			
Contact Na	ame	Title - Contact			F	Phone - Contact*				E	Email - Contact*				
Product-E	Env-Stewards		Product Enviro Compliance			]	NA				P	Product-Env-Stewards@onsemi.com			
uthorized	d Representative*	Title - Representative			F	Phone - Representative*				E	Email - Representative*				
roduct-E	Env-Stewards	Product Enviro Compliance			]	NA				P	Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	Version	n :	Manufacturing Site		Weight*	UOM	Unit Type	
		FSCQ0765RTYDTU 650V QR Cntrlr w		/swtch		2023-06-08 PBB			2223.954	mg	Each				
	cturing Process Inform		Terminal Base	Alloy	-STD-020 MS	I Poting	Dook Dwoo	og Pody	Tomporatu	re Max Time	at Dank To	mporatura Numba	er of Reflow Cy	alas	
	, , , , , , , , , , , , , , , , , , ,		CU Allov NA			L Kaung	0	ess Bouy	C	30	at reak 1e	seconds 3	of Kerlow Cy	cies	
omments	` /		o Andy		in.		U					seconds 3			
omments															
or more i	information regarding materia	al composition	nlease refer to	nage 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (100 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, supplier correct components, supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	11.2	mg	Supplier	Silicon (Si)	7440-21-3		11.2	mg
Die Attach	3.874	mg	Supplier	Silver (Ag)	7440-22-4		0.0387	mg
			A	Lead (Pb)	7439-92-1	7a	3.6416	mg
			Supplier	Tin (Sn)	7440-31-5		0.1937	mg
Lead Frame	1294.62		Supplier	Silver (Ag)	7440-22-4		2.9	mg
			Supplier	Iron (Fe)	7439-89-6		1.59	mg
			Supplier	Copper (Cu)	7440-50-8		1290.0009	mg
			Supplier	Phosphorus (P)	7723-14-0		0.129	mg
Mold Compound-Black	896.3			Metal Hydroxide	proprietary data		31.3705	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		71.704	mg
			Supplier	Carbon Black (C)	1333-86-4		4.4815	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		717.04	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		71.704	mg
Plating	17.4	mg	Supplier	Tin (Sn)	7440-31-5		17.4	mg
Wire Bond - Cu	0.56	mg	Supplier	Copper (Cu)	7440-50-8		0.56	mg